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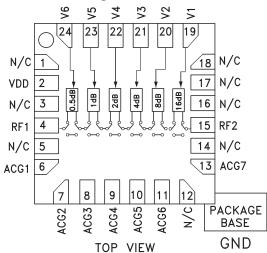
# 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz

# **Typical Applications**

The HMC472LP4(E) is ideal for:

- 3G Infrastructure & access points
- Cellular/3G, LTE & UMB
- WiMAX, WiBN & Fixed Wireless
- Test Equipment and Sensors
- GSM, WCDMA & TD-SCDMA

## **Functional Diagram**



### Features

0.5 dB LSB Steps to 31.5 dB Single Control Line Per Bit TTL/CMOS Compatible Control ± 0.25 dB Typical Step Error Single +5V Supply 24 Lead Ceramic 4x4mm SMT Package: 16mm<sup>2</sup> Included in the HMC-DK004 Designer's Kit

# **General Description**

The HMC472LP4 & HMC472LP4E are broadband 6-bit GaAs IC digital attenuators in low cost leadless surface mount packages. This single positive control line per bit digital attenuator incorporates off chip AC ground capacitors for near DC operation, making it suitable for a wide variety of RF and IF applications. Covering DC to 3.8 GHz, the insertion loss is less than 2.0 dB typical. The attenuator bit values are 0.5 (LSB), 1, 2, 4, 8, and 16 dB for a total attenuation of 31.5 dB. Attenuation accuracy is excellent at  $\pm$  0.25 dB typical step error with an IIP3 of +45 dBm. Six TTL/ CMOS control inputs are used to select each attenuation state. A single Vdd bias of +5V is required.

#### Electrical Specifications, $T_{A} = +25^{\circ}$ C, With Vdd = +5V & VctI = 0/+5V (Unless Otherwise Noted)

Parameter	Frequency (GHz)	Min.	Тур.	Max.	Units	
Insertion Loss	DC - 1.5 GHz 1.5 - 3.0 GHz 3.0 - 3.8 GHz		1.5 2.0 2.3	1.8 2.3 3	dB dB dB	
Attenuation Range	DC - 3.8 GHz		31.5		dB	
Return Loss (RF1 & RF2, All Atten. States)	DC - 3.8 GHz		15		dB	
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States 0.5 - 3.5 dB States 4.0 - 31.5 dB States All Attenuation States All Attenuation States	DC - 1.0 GHz 1.0 - 2.2 GHz 1.0 - 2.2 GHz 2.2 - 3.0 GHz 3.0 - 3.8 GHz	± (020 + 3% of Atten. Setting) Max. ± (0.25 + 3% of Atten. Setting) Max. ± (0.15 + 4% of Atten. Setting) Max. ± (0.30 + 3% of Atten. Setting) Max ± (0.35 + 5% of Atten. Setting) Max.		dB dB dB dB dB		
Input Power for 0.1 dB Compression		0.1 - 3.8 GHz		20		dBm
here a second result of the second seco	- 15.5 dB States - 31.5 dB States	0.1 - 3.8 GHz		45 35		dBm dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		DC - 3.8 GHz		130 140		ns ns

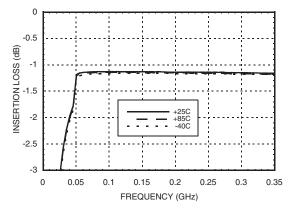
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# ROHS

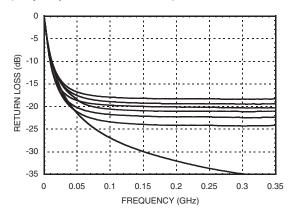
# 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz

## **Insertion Loss**

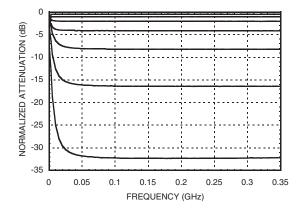


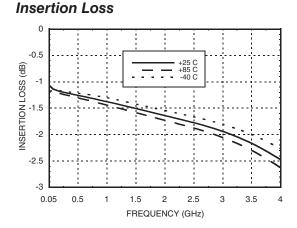
# Return Loss RF1, RF2

(Only Major States are Shown)



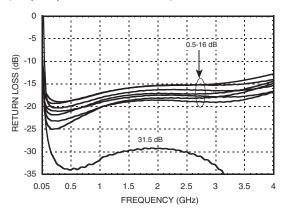
Normalized Attenuation (Only Major States are Shown)





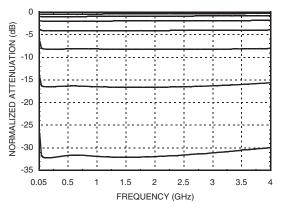
# Return Loss RF1, RF2

(Only Major States are Shown)



# Normalized Attenuation

(Only Major States are Shown)



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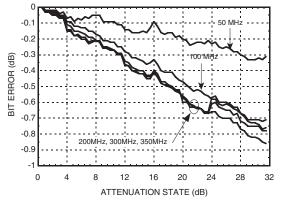




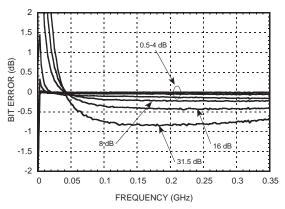
# 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz

Bit Error vs. Attenuation State

# Bit Error vs. Attenuation State



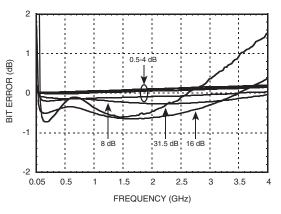
#### **Bit Error vs. Frequency** (Only Major States are Shown)



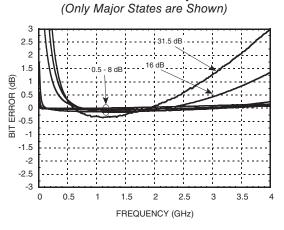
#### 3.8 GHz 1.5 BIT ERROR (dB) 0.5 -0. GHz -1 5 40MHz, 500 MHz 100MHz, 2GHz 0 12 24 28 32 4 8 16 20 ATTENUATION STATE (dB)

# Bit Error vs. Frequency

(Only Major States are Shown)



#### Bit Error vs. Frequency without AC Ground Caps



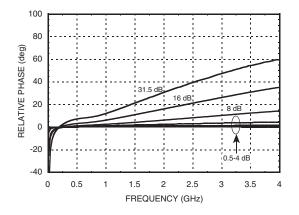
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# ATTENUATORS - DIGITAL - SMT

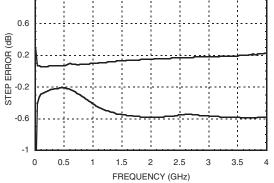
# BoHS

# v06.1108 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL **POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz**

**Relative Phase vs. Frequency** (Only Major States are Shown)



Worst Case Step Error **Between Successive Attenuation States** 



# **Bias Voltage & Current**

Vdd = +5V ± 10%		
Vdd Idd (Typ.) (V) (mA)		
+4.5	4.7	
+5.0	5.0	
+5.5	5.3	

# **Control Voltage**

State	Bias Condition
Low	0 to +0.8 Vdc @ -5 uA Typ.
High	+ 2.0 to + 5.0 Vdc @ 40 uA Typ.
Note: Vdd = +5V	

# **Truth Table**

Control Voltage Input					Attenua-	
V1 16 dB	V2 8 dB	V3 4 dB	V4 2 dB	V5 1 dB	V6 0.5 dB	tion State RF1 - RF2
High	High	High	High	High	High	Reference I.L.
High	High	High	High	High	Low	0.5 dB
High	High	High	High	Low	High	1 dB
High	High	High	Low	High	High	2 dB
High	High	Low	High	High	High	4 dB
High	Low	High	High	High	High	8 dB
Low	High	High	High	High	High	16 dB
Low	Low	Low	Low	Low	Low	31.5 dB
Any combination of the above states will provide an attenuation						

approximately equal to the sum of the bits selected





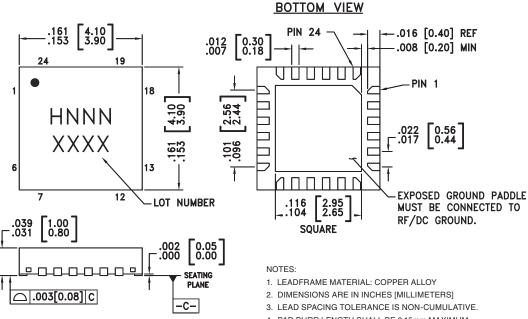
# 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL **POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz**

# Absolute Maximum Ratings

RF Input Power (DC - 3 GHz)	+27 dBm (T = +85 °C)	
Control Voltage Range (V1 to V6)	-1V to Vdd +1V	
Bias Voltage (Vdd)	+7V	
Channel Temperature	150 °C	
Continuous Pdiss (T = 85 °C) (derate 7.7 mW/°C above 85 °C)	0.5 W	
Thermal Resistance	130 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	



# **Outline Drawing**



4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.

- PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM. 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE
- SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

# Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC472LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H472 XXXX
HMC472LP4E	HMC472LP4E RoHS-compliant Low Stress Injection Molded Plastic		MSL1 <sup>[2]</sup>	<u>H472</u> XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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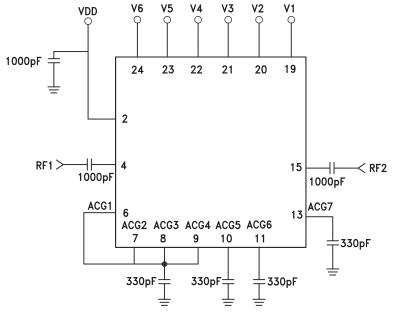
# **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 3, 5, 12, 14, 16, 17, 18	N/C	These pins should be connected to PCB RF ground to maximize performance.	
2	Vdd	Supply Voltage.	
4, 15	RF1, RF2	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required. Select value based on lowest frequency of operation.	RF1'····
6 - 11, 13	ACG1 - ACG7	External capacitors to ground are recommended for low and high frequency operation. Select value for lowest frequency of operation. Place capacitor as close to pins as possible. For operation from 700 to 2700 MHz, these pins may be left unconnected.	
19 - 24	V1 - V6	See truth table and control voltage table.	V1-V5 $V1-V5$ $V1-V$
	GND	Package bottom has an exposed metal paddle that must also be connected to RF/DC Ground.	GND =



0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz

# **Application Circuit**

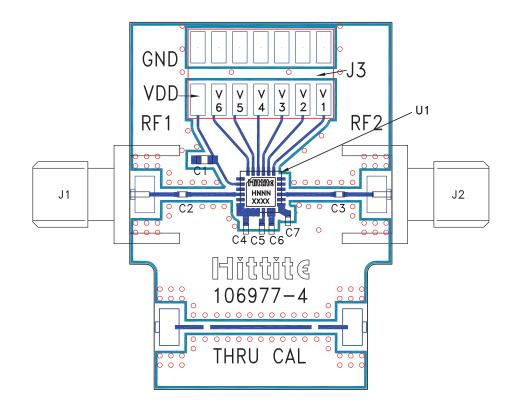


Note: For operations from 700 to 2700 MHz, pins 6 through 13 may be left unconnected.



# 0.5 dB LSB GaAs MMIC 6-BIT DIGITAL POSITIVE CONTROL ATTENUATOR, DC - 3.8 GHz

# Evaluation PCB



# List of Materials for Evaluation PCB 107010 [1]

Item	Description		
J1 - J2	PCB Mount SMA Connector		
J3	14 Pin DC Connector		
C1	1000 pF Capacitor, 0603 Pkg.		
C2, C3	1000 pF Capacitor, 0402 Pkg.		
C4 - C7	330 pF Capacitor, 0402 Pkg.		
U1	HMC472LP4 / HMC472LP4E Digital Attenuator		
PCB [2]	106977 Evaluation PCB		

Reference this number when ordering complete evaluation PCB
 Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.